

Photo Module for PCM Remote Control Systems

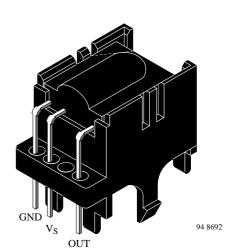
Available types for different carrier frequencies

Type	f_0	Type	f_0
TFML2300	30 kHz	TFML2330	33 kHz
TFML2360	36 kHz	TFML2370	36.7 kHz
TFML2380	38 kHz	TFML2400	40 kHz
TFML2560	56 kHz		

Description

The TFML2..0 is a miniaturized receiver for infrared remote control systems. PIN diode and preamplifier are assembled on lead frame, the epoxy package is designed as IR filter.

The demodulated output signal can directly be decoded by a microprocessor. The main benefit is the reliable function even in disturbed ambient and the protection against uncontrolled output pulses.

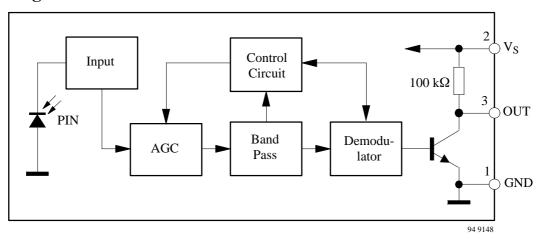


Features

- Photo detector and preamplifier in one package
- Receiver module for transmission codes with long bursts (N≥20 pulses per bit)
- Enhanced integration time against neon light disturbances
- Output active low
- Internal filter for PCM frequency

- Reduced duty cycle for improved immunity against switchmode fluorescent lamps
- Improved shielding against electric field disturbance
- 5 Volt supply voltage
- TTL and CMOS compatibility
- Low power consumption (typical 2.5 mW)

Block Diagram





Absolute Maximum Ratings

 $T_{amb}=25\,^{\circ}C$

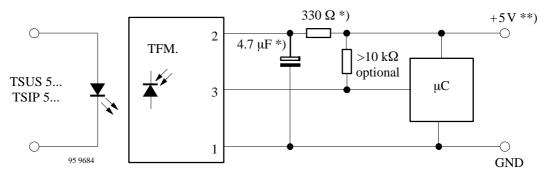
Parameter	Test Conditions	Symbol	Value	Unit
Supply Voltage	(Pin 2)	V_{S}	V _S -0.36.0	
Supply Current	(Pin 2)	Is	5	mA
Output Voltage	(Pin 3)	V_{O}	-0.36.0	V
Output Current	(Pin 3)	I _O	5	mA
Junction Temperature		T_j	100	°C
Storage Temperature Range		T _{stg}	-25+85	°C
Operating Temperature Range		T _{amb}	-25+85	°C
Power Consumption	$(T_{amb} \le 85 \degree C)$	P _{tot}	50	mW
Soldering Temperature	$t \le 5 s$	T_{sd}	260	°C

Basic Characteristics

 $T_{amb} = 25\,^{\circ}C$

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Supply Current (Pin 2)	$V_S = 5 \text{ V}, E_V = 0$	I_{SD}	0.4	0.5	0.8	mA
	$V_S = 5 \text{ V}, E_v = 40 \text{ klx}, \text{ sunlight}$	I_{SH}		1.0		mA
Transmission Distance	$E_v = 0$, test signal see fig.7, IR diode TSIP5201, $I_F = 0.4$ A	d		35		m
Output Voltage Low (Pin 3)	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2,$ $f = f_o$, test signal see fig.7	V _{OSL}			250	mV
Irradiance	Test signal see fig.7	E _{e min}		0.35	0.5	mW/m ²
Irradiance	Test signal see fig.7	E _{e max}	20			W/m ²
Directivity	Angle of half transmission distance	φ _{1/2}		±55		deg

Application Circuit



*) only necessary to suppress power supply disturbances

^{**)} tolerated supply voltage range : $4.5 \text{ V} < \text{V}_S < 5.5 \text{ V}$

Typical Characteristics ($T_{amb} = 25^{\circ}C$ unless otherwise specified)

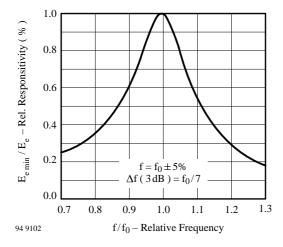


Figure 1. Frequency Dependence of Responsivity

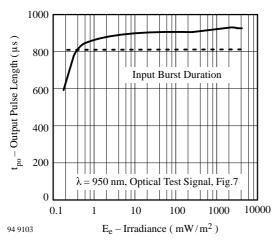


Figure 2. Sensitivity in Dark Ambient

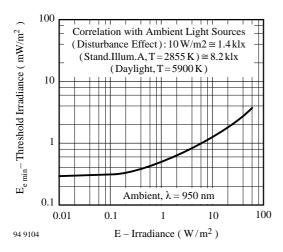


Figure 3. Sensitivity in Bright Ambient

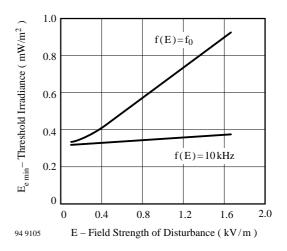


Figure 4. Sensitivity vs. Electric Field Disturbances

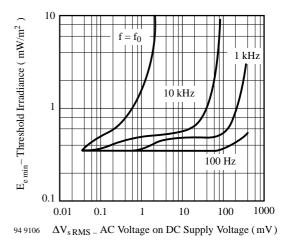


Figure 5. Sensitivity vs. Supply Voltage Disturbances

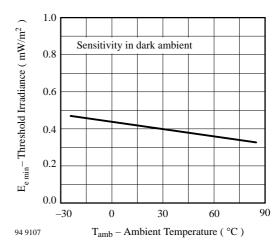
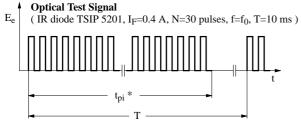


Figure 6. Sensitivity vs. Ambient Temperature



 $N \ge 20$ Pulses is recommended for optimal function

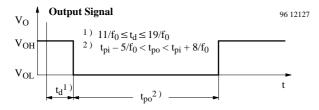
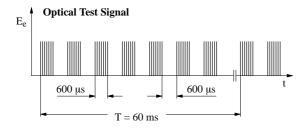


Figure 7. Output Function



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Vo Output Signal, (see Fig.10)

VoH
VoL
Ton
Toff

Figure 8. Output Function

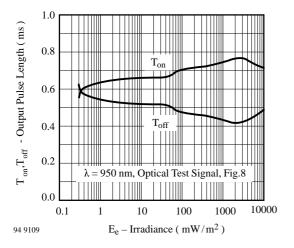


Figure 9. Output Pulse Diagram

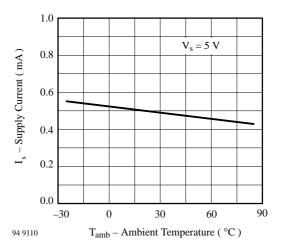


Figure 10. Supply Current vs. Ambient Temperature

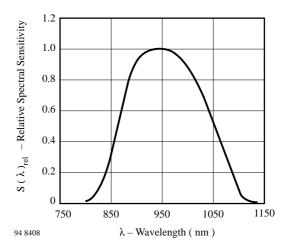


Figure 11. Spectral Response

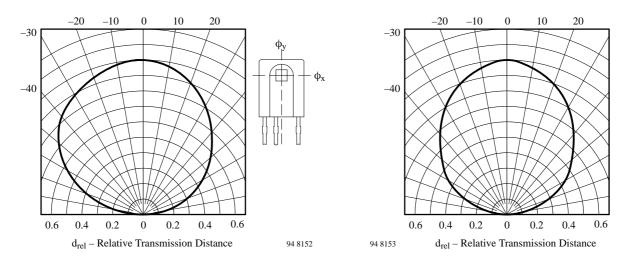
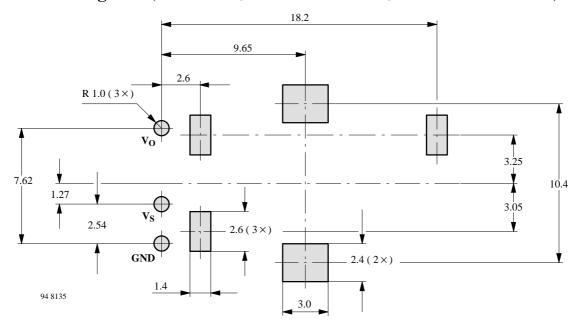


Figure 12. Vertical Directivity ϕ_V

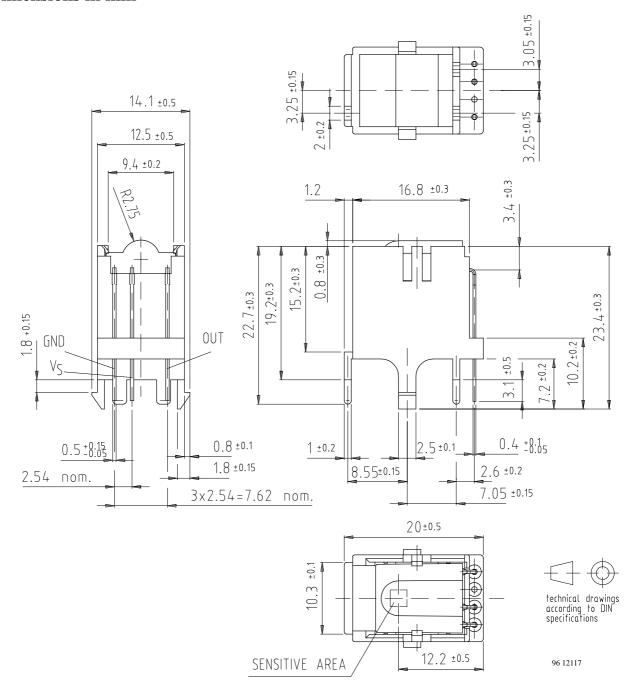
Figure 13. Horizontal Directivity ϕ_X

Board Hole Diagram (Solder side, dimensions in mm, tolerances ± 0.3 mm)





Dimensions in mm





Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

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